公TDK 积层贴片陶瓷片式电容器 C1608CH1H331J080AA

RoHS Reach Halogen Free Pb Free

交货型号	C1608CH1H331JT****	\sim
用途	一般等级	
特点	General 一般(~75V)	
系列	C1608 [EIA 0603]	6
状态	▲ 量产体制(新设计非推荐)	В

尺寸		
长度(L)	1.60mm ±0.10mm	
宽度(W)	0.80mm ±0.10mm	
厚度(T)	0.80mm ±0.10mm	
端子宽度(B)	0.20mm Min.	
端子间隔(G)	0.30mm Min.	
推荐焊盘布局(PA)	0.70mm to 1.00mm(Flow Soldering)	
1世存/产益/即问 (FA)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PB)	0.80mm to 1.00mm(Flow Soldering)	
1世存/产益/II/inj (FD)	0.60mm to 0.80mm(Reflow Soldering)	
推荐焊盘布局(PC)	0.60mm to 0.80mm(Flow Soldering)	
1世行/干血/叩/미/U/U/	0.60mm to 0.80mm(Reflow Soldering)	

	电气特性	
电容	$330 \mathrm{pF} \pm 5\%$	
额定电压	50VDC	
	CH(0±60ppm/°C)	
Q (Min.)	1000	
	10000M Ω	

	其他
焊接方法	流体
淬按 力法	回流
AEC-Q200	NO
包装形式	纸编带 (180mm卷筒)
包装个数	4000pcs

 $!\ \mbox{Images}$ are for reference only and show exemplary products.

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! All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

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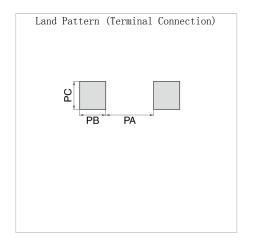
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Associated Images



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